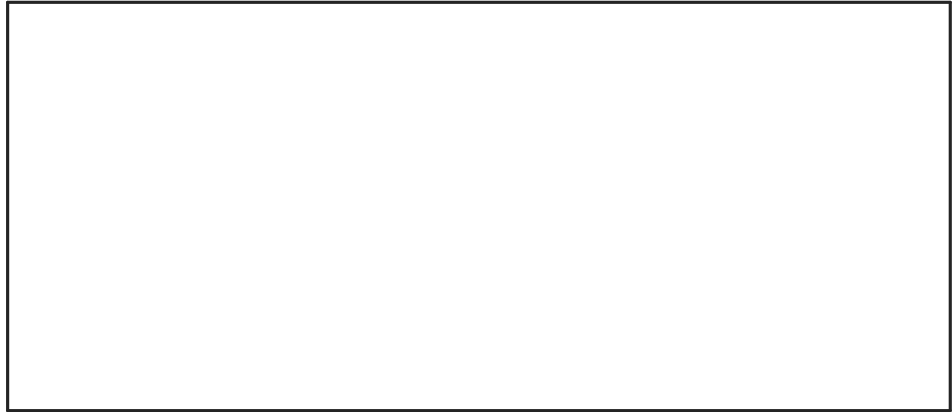


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10837	REV: A	SUN REV: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 6/5/2015	11:25:25 AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10837	REV: A	SUN REV: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/5/2015	11:25:26 AM	TEXAS INSTRUMENTS

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